



Acxsys Corporation
Royal Bank Plaza, North Tower
200 Bay Street, Suite 2400
P.O. Box 45, Toronto, ON M5J 2J1

Romi Kohli
Vice President, Technology
Tel: (416) 869-8318
Fax: (416) 869-5080
rkohli@interac.ca

November 18, 2016

ID TECH
Simon LEE
10721 Walker St.
Cypress, CA
90630 USA

RE: LEVEL 2 LETTER OF APPROVAL

Dear Simon LEE,

Acxsys Corporation ("Acxsys") has developed a dual interface contact and contactless chip payment standard specification for Interac Association/Acxsys Corporation payment systems (the "System"). You have requested that your product be accredited for dual interface certification as it relates to the System. This letter confirms that the following product has been approved by Acxsys for the Interac DI-Flash approved product list.

Acxsys approval number:	IN16-18-11-VIV20010
Commercial Product Name:	UniPayIII
Technical Product Name:	UniPayIII
Application Version:	Interac 1.5, v1.00
Technical Specification Version:	Dual Interface Reader Terminal specification for IDP v1.5
Technical features of the product:	Contactless reader only, Online only, No Display
Test Report Number	M16REP10-20-1_Final
Approval date:	November 18, 2016
Renewal date:	May 01, 2020

As confirmed by the Acxsys Certification Agent that performed the assessment, this letter confirms that the product as described above has successfully passed the test session according to Interac Association Specifications and Certification Guidelines for Interac–DI Flash contact and contactless interface.

CONDITIONS

This letter does not constitute an endorsement or warranty by Acxsys regarding the functionality,



Acxsys Corporation
Royal Bank Plaza, North Tower
200 Bay Street, Suite 2400
P.O. Box 45, Toronto, ON M5J 2J1

security, quality or performance of the submitted product, including without limitation any warranties of merchantability, fitness for purpose or non-infringement, all of which are expressly disclaimed by Acxsys.

You are authorized to communicate to others that the product above has been certified as compliant with the Interac Association Specifications and Certification Guidelines for the Interac-DI Flash contact and contactless interface. However, you are not permitted to use the INTERAC word-mark, the INTERAC logo or any other any trade-marks owned or used by Interac Association and Acxsys Corporation, or to issue a press release or any other public statement naming Interac Association or Acxsys Corporation, without the prior written consent of Acxsys.

Acxsys' approval applies only to the product as described above. Acxsys reserves the right to require further testing of the product and/or to utilize the above product as a reference in respect of certification and approval of other Interac Di-Flash products.

The issuance of this letter is conditioned upon all necessary agreements having been executed, including without limitation, the applicable license agreements with Acxsys and this letter of approval shall be of no force and effect unless such agreements have been executed contemporaneously with or prior to the issuance of this letter. The issuance of this letter is further conditioned upon ID TECH maintaining its approval from Acxsys.

Approval granted by Acxsys does not supersede any additional requirements that may be imposed on you, including by any of your customers.

Sincerely,

A handwritten signature in black ink, appearing to read "Romi Kohli". The signature is fluid and cursive, with a large loop at the beginning.

Romi Kohli
Vice President, Technology



Acxsys Corporation
Royal Bank Plaza, North Tower
200 Bay Street, Suite 2400
P.O. Box 45, Toronto, ON M5J 2J1

Approval Conditions

1. . A Dual Interface configuration has been submitted to evaluation. Contact profiles need to be validated during integration.
2. The product had been tested against the following test plan :
 - Contactless Reader Terminal Application Certification Guide v1.5
 - Contactless Reader Terminal Application Certification Guide v1.5 - Appendix FMobile Interac Flash-Nov 2014
 - Contactless Reader Terminal Application Certification Guide Bulletin 2-2014

